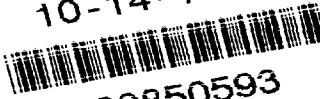


10-5-98

10-14-1998



100850593

To the Honorable Commissioner of Patents

4 original documents or copy thereof.

1. Name of conveying party(is):
Wen-Ying WEN
and
Chih-Ming CHEN

2. Name and address of receiving parties:

Name: Winbond Electronics Corp.

Internal Address: _____

Street Address: No. 4, Creation Rd. III, Science-Based Industrial Park,

City: Hsinchu State: _____ Zip: _____

Country: Taiwan, R.O.C.

Additional name(s) of conveying parties attached? Yes No

Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance:

Assignment Merger

Security Agreement Change of Name

Other _____

Execution Date: July 20, 1998

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: July 20, 1998

A. Patent Application No(s):

B. Patent No(s):

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Richard P. Berg
Name: LADAS & PARRY

Internal Address: _____

Street Address: 5670 Wilshire Boulevard, #2100

10/14/1998 NGUYEN 00000025 09166680

01 FC:561 40.00 DP

City: Los Angeles State: CA Zip: 90036

6. Total number of application and patents involved: [1]

7. Total fee (37 CFR 3.41) \$ 40.00

Enclosed

Any additional fees which may be required are

Authorized to be charged to deposit account

No. 12-0415

8. Deposit account number:

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Richard P. Berg
Name of Person Signing

October 5, 1998
Date

Total number of pages including cover sheet, attachments, and document: [2] plus \$40 check

Mail documents to be recorded with required cover sheet information to:

Commissioner of Patents and Trademarks
Box Assignments
Washington, D.C. 20231

Public burden reporting for this sample cover sheet is estimated to average about 30 minutes per document to be recorded, including time for reviewing the document and gathering the data needed, and completing and reviewing the sample cover sheet. Send comments regarding this burden estimate to the U.S. Patent and Trademark Office, Office of Information Systems, PK2-1000C, Washington, D.C. 20231, and to the Office of Management and Budget, Paperwork Reduction Project (0651-0011), Washington, D.C., 20503.

0492 - 22 75-2

ASSIGNMENT

WHEREAS, WEN-YING WEN, CHIH-MING CHEN
hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements
as described and set forth in the below identified application for United States Letters Patent:

Title: A HIGH Q INDUCTOR AND ITS FORMING METHOD

Filed: _____ Serial No. _____

Executed on: July 20, 1998

WHEREAS, Winbond Electronics Corp. of No. 4, Creation Rd. III, Science-Based Industrial
Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the
said invention and application and in any U.S. Letters Patent which may be granted on the
same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known
that, for good and valuable consideration, receipt of which is hereby acknowledged by
Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell,
assign and transfer unto the said Assignee, and Assignee's successors and assigns, all
his/her/their rights, title and interest in and to the said invention and application and all future
improvements thereon, and in and to any Letters Patent which may hereafter be granted on the
same in the United States, the said interest to be held and enjoyed by said Assignee as fully and
exclusively as it would have been held and enjoyed by said Assignor had this Assignment and
transfer not been made, to the full end and term of any Letters Patent which may be granted
thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion,
reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to
said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said
application and/or applications, execute, verify, acknowledge and deliver all such further
papers, including applications for Letters Patent and for the reissue thereof, and instruments of
assignment and transfer thereof, and will perform such other acts as Assignee lawfully may
request, to obtain or maintain Letters Patent for said invention and improvement, and to vest
title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the
date(s) indicated.

Wen-Ying Wen
Wen-Ying WEN

✓ 1998. 7. 20
Date:

Chih-ming Chen
Chih-Ming CHEN

✓ 1998. 7. 20
Date: